

RGTH40TK65D

650V 20A Field Stop Trench IGBT

V _{CES}	650V
I _{C(100°C)}	14A
V _{CE(sat) (Typ.)}	1.6V@I _C =20A
P_D	56W

Features

- 1) Low Collector Emitter Saturation Voltage
- 2) High Speed Switching
- 3) Low Switching Loss & Soft Switching
- 4) Built in Very Fast & Soft Recovery FRD (RFN - Series)
- 5) Pb free Lead Plating; RoHS Compliant

Applications

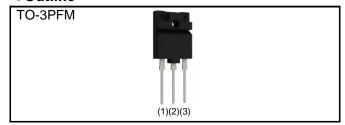
PFC

UPS

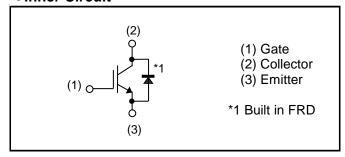
Power Conditioner

ΙH

Outline



●Inner Circuit



Packaging Specifications

	Packaging	Tube
	Reel Size (mm)	-
Tuno	Tape Width (mm)	-
Туре	Basic Ordering Unit (pcs)	450
	Packing Code	C11
	Marking	RGTH40TK65D

◆Absolute Maximum Ratings (at T_C = 25°C unless otherwise specified)

Parameter		Symbol	Value	Unit	
Collector - Emitter Voltage		V _{CES}	650	V	
Gate - Emitter Voltage		V_{GES}	±30	V	
Callactor Current	T _C = 25°C	I _C	23	А	
Collector Current	T _C = 100°C	I _C	14	А	
Pulsed Collector Current	I _{CP} *1	80	А		
Diode Forward Current	T _C = 25°C	I _F	26	А	
Diode Forward Current	T _C = 100°C	I _F	15	А	
Diode Pulsed Forward Current		I _{FP} *1	80	А	
T _C = 25°C		P _D	56	W	
Power Dissipation	T _C = 100°C	P _D	28	W	
Operating Junction Temperature		T _j	-40 to +175	°C	
Storage Temperature		T _{stg}	-55 to +175	°C	

^{*1} Pulse width limited by T_{jmax.}

●Thermal Resistance

Parameter	Cymbol	Values			Unit
Farameter	Symbol	Min.	Тур.	Max.	Offic
Thermal Resistance IGBT Junction - Case	$R_{\theta(j-c)}$	-	-	2.64	°C/W
Thermal Resistance Diode Junction - Case	$R_{\theta(j-c)}$	-	-	3.93	°C/W

●IGBT Electrical Characteristics (at T_j = 25°C unless otherwise specified)

Parameter	Symbol	Conditions	Values			Unit	
r ai ai nietei	Symbol Conditions -		Min.	Тур.	Max.	Offic	
Collector - Emitter Breakdown Voltage	BV _{CES}	$I_C = 10 \mu A, V_{GE} = 0 V$	650	1	-	V	
Collector Cut - off Current	I _{CES}	$V_{CE} = 650V, V_{GE} = 0V$	1	1	10	μΑ	
Gate - Emitter Leakage Current	I _{GES}	$V_{GE} = \pm 30V, \ V_{CE} = 0V$	1	-	±200	nA	
Gate - Emitter Threshold Voltage	$V_{GE(th)}$	$V_{CE} = 5V, I_{C} = 13.3 \text{mA}$	4.5	5.5	6.5	V	
Collector - Emitter Saturation Voltage	V _{CE(sat)}	$I_C = 20A, V_{GE} = 15V$ $T_j = 25^{\circ}C$ $T_j = 175^{\circ}C$	-	1.6 2.1	2.1	V	

●IGBT Electrical Characteristics (at T_j = 25°C unless otherwise specified)

Parameter	Symbol	Conditions -		Unit		
Farameter	Symbol		Min.	Тур.	Max.	Offic
Input Capacitance	C _{ies}	V _{CE} = 30V	-	1060	-	
Output Capacitance	C _{oes}	$V_{GE} = 0V$	-	47	-	pF
Reverse Transfer Capacitance	C _{res}	f = 1MHz	-	18	-	
Total Gate Charge	Q_g	V _{CE} = 300V	-	40	-	
Gate - Emitter Charge	Q _{ge}	I _C = 20A	-	9	-	nC
Gate - Collector Charge	Q_{gc}	V _{GE} = 15V	-	15	-	
Turn - on Delay Time	t _{d(on)}	$I_C = 20A, V_{CC} = 400V$	-	22	-	
Rise Time	t _r	$V_{GE} = 15V, R_G = 10\Omega$	-	25	-	200
Turn - off Delay Time	t _{d(off)}	T _j = 25°C	-	73	-	ns
Fall Time	t _f	Inductive Load	-	48	-	
Turn - on Delay Time	t _{d(on)}	$I_C = 20A, V_{CC} = 400V$	-	22	-	
Rise Time	t _r	$V_{GE} = 15V, R_{G} = 10\Omega$	-	25	-	200
Turn - off Delay Time	t _{d(off)}	T _j = 175°C	-	83	-	ns
Fall Time	t _f	Inductive Load	-	58	-	
		$I_C = 80A, V_{CC} = 520V$				
Reverse Bias Safe Operating Area	RBSOA	$V_P = 650V, V_{GE} = 15V$	FU	LL SQUA	RE	-
		$R_G = 60\Omega, T_j = 175^{\circ}C$				

•FRD Electrical Characteristics (at $T_j = 25^{\circ}C$ unless otherwise specified)

Dovometer	Symbol	Conditions	Values			Unit
Parameter			Min.	Тур.	Max.	Unit
Diode Forward Voltage	V _F	I _F = 20A T _j = 25°C	-	1.45	1.9	V
		T _j = 175°C	-	1.25	-	
Diode Reverse Recovery Time	t _{rr}	I _F = 20A	-	58	-	ns
Diode Peak Reverse Recovery Current	I _{rr}	$V_{CC} = 400V$ $di_F/dt = 200A/\mu s$ $T_j = 25^{\circ}C$	-	6.3	-	А
Diode Reverse Recovery Charge	Q_{rr}		-	0.20	-	μC
Diode Reverse Recovery Time	t _{rr}	I _F = 20A	-	256	-	ns
Diode Peak Reverse Recovery Current	I _{rr}	$V_{CC} = 400V$ $di_F/dt = 200A/\mu s$	-	10.4	-	А
Diode Reverse Recovery Charge	Q_{rr}	T _j = 175°C	-	1.35	-	μC

Fig.1 Power Dissipation vs. Case Temperature

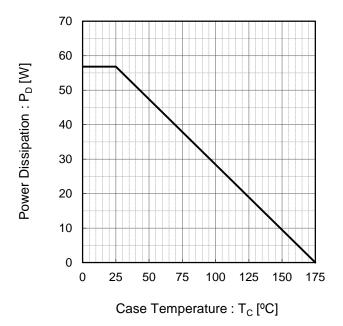


Fig.2 Collector Current vs. Case Temperature

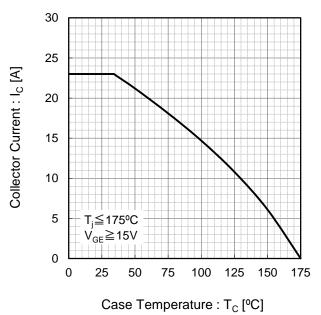


Fig.3 Forward Bias Safe Operating Area

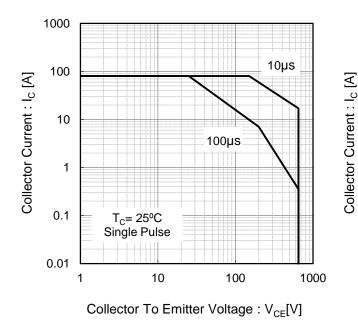


Fig.4 Reverse Bias Safe Operating Area

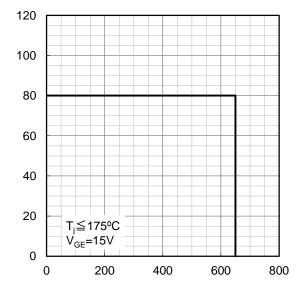


Fig.5 Typical Output Characteristics

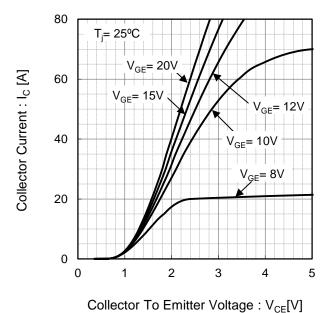
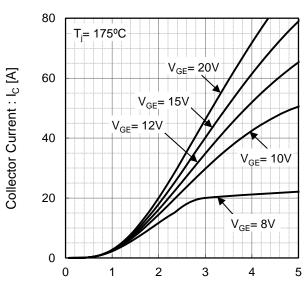


Fig.6 Typical Output Characteristics



Collector To Emitter Voltage : V_{CE}[V]

Fig.7 Typical Transfer Characteristics

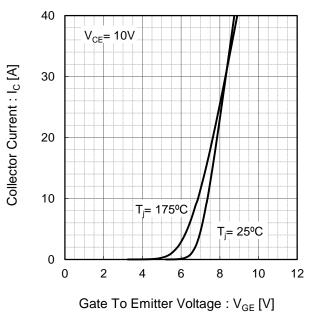


Fig.8 Typical Collector To Emitter Saturation Voltage vs. Junction Temperature

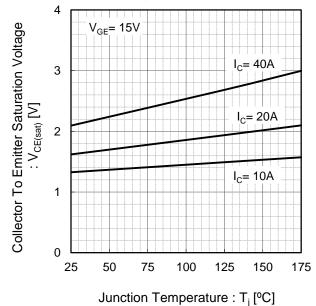
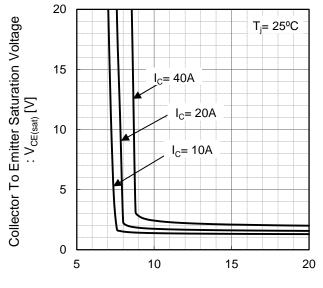
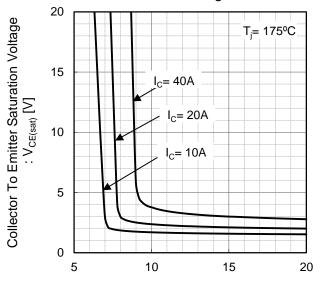


Fig.9 Typical Collector To Emitter Saturation Voltage vs. Gate To Emitter Voltage



Gate To Emitter Voltage : V_{GE} [V]

Fig.10 Typical Collector To Emitter Saturation Voltage vs. Gate To Emitter Voltage



Gate To Emitter Voltage: V_{GE} [V]

Fig.11 Typical Switching Time vs. Collector Current

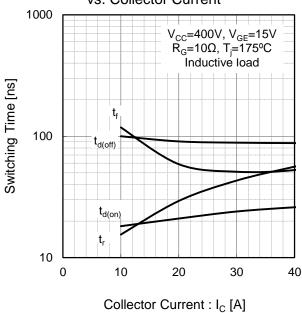
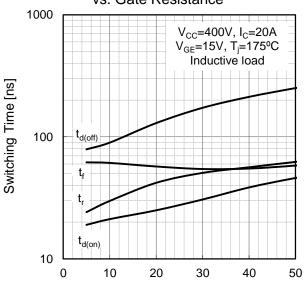


Fig.12 Typical Switching Time vs. Gate Resistance



Gate Resistance : $R_G[\Omega]$

Fig.13 Typical Switching Energy Losses vs. Collector Current 10 Switching Energy Losses [mJ] 1 $\mathsf{E}_{\mathsf{off}}$ 0.1 V_{CC} =400V, V_{GE} =15V R_{G} =10 Ω , T_{j} =175°C Inductive load 0.01 0 10 20 30 40 Collector Current : I_C [A]

vs. Gate Resistance

10

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Fig.14 Typical Switching Energy Losses

Fig.15 Typical Capacitance vs. Collector To Emitter Voltage 10000 Cies 1000 Capacitance [pF] 100 Coes Cres 10 f=1MHz $V_{GE}=0V$ T_i=25°C 0.01 0.1 1 10 100 Collector To Emitter Voltage : V_{CE}[V]

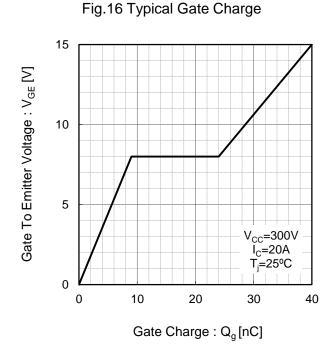


Fig.17 Typical Diode Forward Current vs. Forward Voltage 80 Forward Current: I_F [A] 60 40 20 T_i= 175°C T_i= 25°C 0 0 0.5 1.5 2 2.5 3 Forward Voltage: V_F[V]

Fig.18 Typical Diode Reverse Recovery Time vs. Forward Current 400 V_{CC}=400V di_F/dt=200A/µs Reverse Recovery Time: t_{rr} [ns] Inductive load 300 T_i= 175°C 200 100 T_i= 25°C 0 0 10 20 30 40 50 Forward Current : I_F [A]

Fig.19 Typical Diode Reverse Recovery Current vs. Forward Current

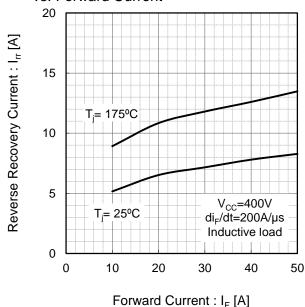
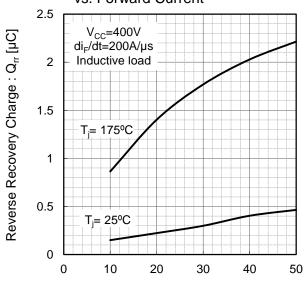


Fig.20 Typical Diode Reverse Recovery Charge vs. Forward Current



Forward Current : I_F [A]

Fig.21 IGBT Transient Thermal Impedance

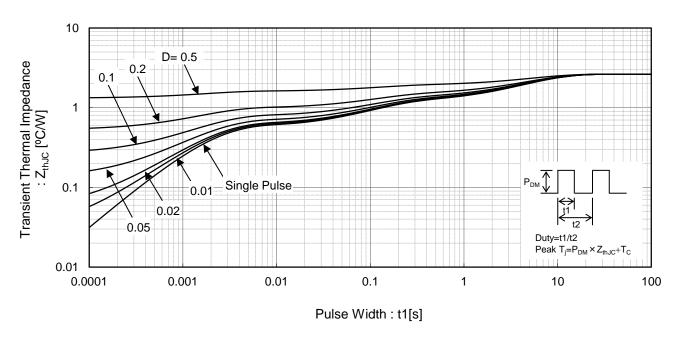
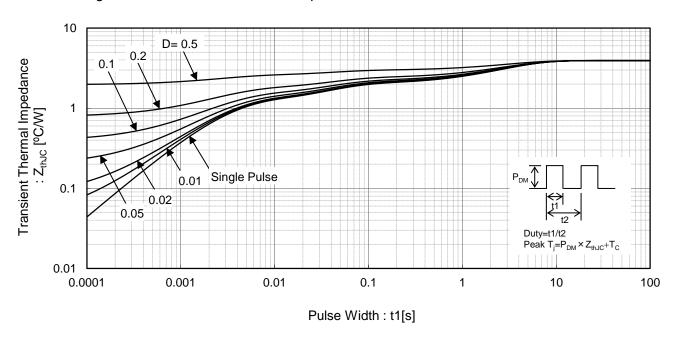


Fig.22 Diode Transient Thermal Impedance



●Inductive Load Switching Circuit and Waveform

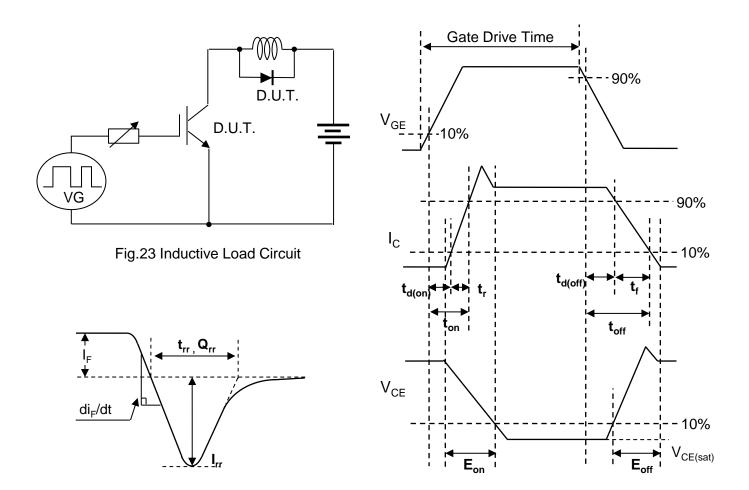


Fig.25 Diode Reverce Recovery Waveform

Fig.24 Inductive Load Waveform

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RGTH40TK65D - Web Page

Distribution Inventory

Part Number	RGTH40TK65D
Package	TO-3PFM
Unit Quantity	450
Minimum Package Quantity	450
Packing Type	Tube
Constitution Materials List	inquiry
RoHS	Yes